NUP4000

Bi-directional TVS Array for High-Speed Data Line Protection

The NUP4000 transient voltage suppressor is designed to protect equipment attached to up to four high speed communication lines from ESD, EFT, and lightning.

Features:

- SO-8 Package
- Peak Power 400 W 8 x 20 µS
- ESD Rating: IEC 61000-4-2 (ESD) ±15 kV (air) ±8 kV (contact) IEC 61000-4-4 (EFT) 40 A (5/50 ns) IEC 61000-4-5 (lightning) 12 A (8/20 μs)
- UL Flammability Rating of 94 V–0
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications:

- High Speed Communication Line Protection
- 15 V Data and I/O Lines
- Microprocessor Based Equipment
- LAN/WAN Equipment
- Servers
- Notebook and Desktop PC
- Serial and Parallel Ports
- Peripherals

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation 8 x 20 μs @ T_A = 25°C (Note 1)	P _{pk}	400	W
Peak Pulse Current 8 x 20 μs @ T _A = 25°C (Note 1)	I _{PP}	10	A
Junction and Storage Temperature Range	T _J , T _{stg}	−55 to +150	°C
Lead Solder Temperature – Maximum 10 Seconds Duration	ΤL	260	°C

1. Non-repetitive current pulse 8 x 20 μ S exponential decay waveform

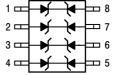


ON Semiconductor®

http://onsemi.com

SO-8 VOLTAGE SUPPRESSOR 400 WATTS PEAK POWER 15 VOLTS

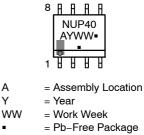






SO-8 CASE 751

MARKING DIAGRAM



(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]	
NUP4000DR2G	SO-8 (Pb-Free)	2500 / Tape & Reel	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NUP4000

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Working Voltage	V _{RWM}	-	-	15	V
Reverse Breakdown Voltage @ I _t = 1.0 mA	V _{BR}	16.7	-	-	V
Reverse Leakage Current @ V _{RWM} = 15 Volts	I _R	N/A	-	1.0	μΑ
Maximum Clamping Voltage @ I_{PP} = 1.0 A, 8 x 20 μS	V _C	N/A	-	24	V
Maximum Clamping Voltage @ I_{PP} = 5.0 A, 8 x 20 μS	V _C	N/A	-	30	V
Maximum Peak Pulse Current	I _{PP}	-	-	10	А
Junction Capacitance @ V_R = 0 V, f = 1 MHz	CJ	-	-	75	pF

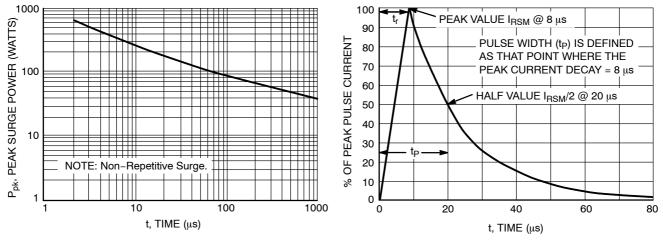
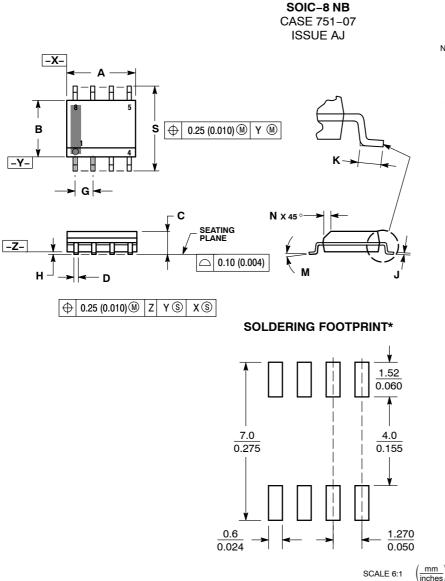


Figure 1. Pulse Width

Figure 2. 8 \times 20 μs Pulse Waveform

NUP4000

PACKAGE DIMENSIONS



details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

*For additional information on our Pb-Free strategy and soldering

SCALE 6:1

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NOTES

- 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER. 2 DIMENSION A AND B DO NOT INCLUDE 3
- MOLD PROTRUSION. 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- PER SIDE
- PROTRUSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL 5. IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751–01 THRU 751–06 ARE OBSOLETE. NEW STANDARD IS 751–07. 6

	MILLIMETERS		MILLIMETERS INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.80	5.00	0.189	0.197		
В	3.80	4.00	0.150	0.157		
С	1.35	1.75	0.053	0.069		
D	0.33	0.51	0.013	0.020		
G	1.27 BSC		0.050 BSC			
н	0.10	0.25	0.004	0.010		
J	0.19	0.25	0.007	0.010		
Κ	0.40	1.27	0.016	0.050		
М	0 °	8 °	0 °	8 °		
Ν	0.25	0.50	0.010	0.020		
s	5.80	6.20	0.228	0.244		